Motor Waveform Data (Tests performed with common 5V PC fan):

1. 3-Phase Sensorless Commutation Scheme_4ms
2. 3-Phase Sensorless Commutation Scheme_2ms
3. Phase U Active
4. Phase V Active
5. Phase W Active
6. 3-Phase Sensorless Commutation Scheme at Low Speed

**Section 1:** 3-Phase Sensorless Commutation Scheme_1

**Section 2:** 3-Phase Sensorless Commutation Scheme_2
Section 3: Phase U Active

Section 4: Phase V Active
Section 5: Phase W Active

Section 6: 3-Phase Sensorless Commutation Scheme at Low Speed
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